IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Application of:

Grimm et al.

Continuation of Serial No. 09/202,700

Title: A REACTIVE HOTMELT ADHESIVE COMPOSITION FOR INSULATING

GLASS

INFORMATION DISCLOSURE STATEMENT

Mail Stop Patent Application Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450

Sir:

Transmitted herewith is an Information Disclosure Statement ("IDS") in the above-referenced application, together with an IDC form listing all references cited. Each reference has been previously submitted in parent application 09/202,700 and therefore the references are not included in this IDS.

Respectfully submitted,

Daniel S. Ortiz

RN 25,123

Attorney for Applicant

(610) 278-4934

Henkel Corporation Law Department 2500 Renaissance Blvd, Suite 200 Gulph Mills, PA 19406

/mlc

Enclosure

1. IDC

PTO/SB/08A (10-01)

Approved for use through 10/31/2002. OMB 0651-0031

Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

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	1			U.S. PATENT	DOCUMENTS		
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¹Applicant's unique citation designation number (optional). ²See Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. ³Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶Applicant is to place a check mark here if English Language Translation is attached.

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